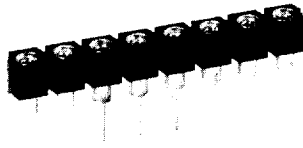


Terminal Strips, Four-Fingered Contact

500 Series



510AG91D08ESL

FEATURES:

- Available in strips of 1 to 20
- Breakaway feature for breaking strips into any desired shorter lengths (no special tooling required)
- Contact features closed end construction eliminating any solder or flux wicking problems
- Two-piece tapered entry closed entry inner contact and outer sleeve
- Accepts any IC lead and component leads .016" - .021" (0.41 - 0.53) dia., .105" (2.67) minimum length
- Uses: microprocessor sockets, hybrid IC sockets, Q.I.L. sockets, component sockets and test points
- Machined (Premium Series) and stamped (Economy Series) contacts are available

APPLICATION DIMENSIONS:

- PCB Thickness Range: Standard .062" and .092" (1.57 and 2.34)
- PCB Hole Size Range: .035" ± .003" (0.89 ± 0.08) PC tail, .055" ± .003" (1.40 ± 0.08) Solderless wrap
- IC Pin Dimension Range: .009" x .015" (0.23 x 0.38) through .011" x .020" (0.28 x 0.51) .016" x .021" (0.41 x 0.53) round lead .105" (2.67) min. length

MATERIAL SPECIFICATIONS:

Insulator.....Thermoplastic polyester. UL rated 94V-0
 Inner Contact.....Beryllium copper, gold or tin/lead plated
 SleeveBrass, gold or tin/lead plated

PART NUMBERS

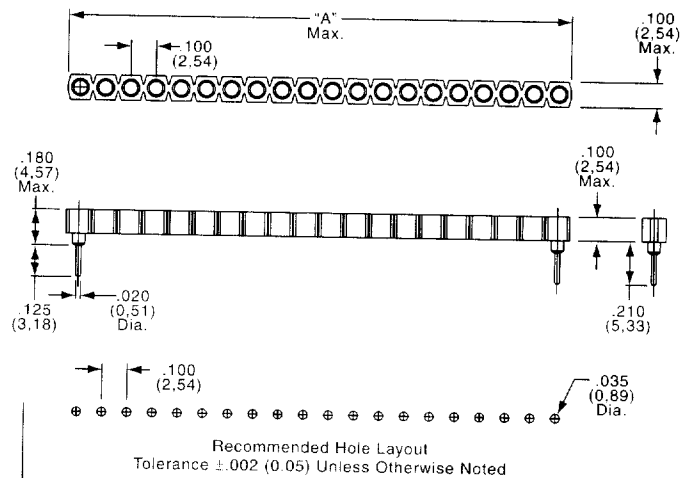
Economy Series	Premium Series	Number of Contacts	Contact Plating	Sleeve Plating	Dim. A
510AG90D10ES	510-AG90D-10	10	Gold	Gold	1.000 (25.40)
510AG90D10ESL			Low Gold	Gold	
510AG91D10ES	510-AG91D-10		Gold	Tin/Lead	
510AG91D10ESL			Low Gold	Tin/Lead	
510AG92D10ES	510-AG92D-10	20	Tin/Lead	Tin/Lead	2.000 (50.80)
510AG90D20ES	510-AG90D-20		Gold	Gold	
510AG90D20ESL			Low Gold	Gold	
510AG91D20ES	510-AG91D-20		Gold	Tin/Lead	
510AG91D20ESL		Low Gold	Tin/Lead		
510AG92D20ES	510-AG92D-20		Tin/Lead	Tin/Lead	

For sizes not shown or for wire-wrap termination, please consult Tyco Electronics.

ECONOMY AND PREMIUM SERIES - .180 PC TAIL PINS

510-AG45D-XX, 510AG45DXXES(L) - Gold Contact, Gold Sleeve
 510-AG44D-XX, 510AG44DXXES(L) - Gold Contact, Tin/Lead Sleeve
 510-AG42D-XX, 510AG42DXXES(L) - Tin/Lead Contact, Tin/Lead Sleeve

Note: Before ordering, see Cross Reference in Section 15 for equivalent Tyco Electronics Part Number.



PERFORMANCE SPECIFICATIONS:

MECHANICAL

- VibrationPassed MIL-STD-1344, Method 2005.1, Condition II, 10 G's
- ShockPassed MIL-STD-1344, Method 2004.1, Condition C, 100 G's
- DurabilityPassed MIL-STD-1344, Method 2016
- Normal Force125 Grams (4.4 oz.) average with .018" (0.46) dia. polished steel pin (Premium Series)
 200 Grams (7.1 oz.) average with .018" (0.46) dia. polished steel pin (Economy Series)
- Inner Contact Retention ..
 in Sleeve7.5 Lbs. per line average
- Sleeve Retention
 in Plastic3.0 Lbs. per line minimum
- SolderabilityPassed MIL-STD-202F, Method 208
- Insertion ForcePremium - 134 Grams (4.7 oz.) average with a .018" (0.46) dia. polished steel pin
 Economy - 179 Grams (6.3 oz.) average with a .018" (0.46) dia. polished steel pin
- Withdrawal Force63 Grams (2.2 oz.) average with a .018" (0.46) dia. polished steel pin

ELECTRICAL

- Contact Resistance10 Milliohms max.
- Contact Rating.....3 Amps
- Capacitance1.0 pF per MIL-STD-202, Method 305 (contact to contact)
- Insulation Resistance.....5,000 Megohms min. @ 500 VDC per MIL-STD-1344, Method 3003.1
- Dielectric Withstanding
 Voltage1,000 Volts RMS per MIL-STD-1344, Method 3001.1

ENVIRONMENTAL

- HumidityPassed MIL-STD-1344, Method 1002.2, Cond. II
- Thermal ShockPassed MIL-STD-1344, Method 1003.1, Cond. A
- Operation TemperatureGold inner contact -55°C to +125°C
 Tin/lead inner contact -55°C to +105°C